

REMARKS

Applicants respectfully request reconsideration of the application in view of the following remarks.

Obviousness Rejections Under 35 U.S.C. § 103

To reject a claim or claims under 35 U.S.C. § 103, the Examiner bears the initial burden of establishing a prima facie case of obviousness. M.P.E.P. § 2142. When establishing a prima facie case of obviousness, the Examiner must set forth evidence showing that the following three criteria are satisfied:

First, there must be some suggestion or motivation, either in the references themselves or in the knowledge generally available to one of ordinary skill in the art, to modify the references or to combine teachings. Second, there must be a reasonable expectation of success. Finally, the prior art references (or references when combined) must teach or suggest all the claim limitations.

M.P.E.P. § 2143.

The teaching or suggestion to make the claimed combination and the reasonable expectation of success must both be found in the prior art, and not based on the applicant's disclosure. M.P.E.P. § 2142 (citing *In re Vaeck*, 20 U.S.P.Q.2d 1438 (Fed. Cir. 1991)). Also, the evidentiary showing of a motivation or suggestion to combine prior art references "must be clear and particular." *In re Dembiczak*, 175 F.3d 994, 999, 50 U.S.P.Q.2d 1614, 1617 (Fed. Cir. 1999).

Obviousness Rejection Based on United States Patent 6,172,611 to Hussain et al. in View of United States Patent 5,675,297 to Gose et al.

Claims 1, 6-9, 14, 16, 17, 22, 24-27, 31, 32, 34-40, and 49 were rejected under 35 U.S.C. § 103(a) as being unpatentable over United States Patent 6,172,611 to Hussain et al. (hereinafter "Hussain") in view of United States Patent 5,675,297 to Gose et al. (hereinafter "Gose"). Applicants respectfully traverse this rejection as set forth below.

Claims 1, 6-9, 14, 16, 17, 22, 24, and 37-40

Hussain discloses an apparatus for monitoring the thermal state of a system.

Column 2, Lines 60-67; Column 3, Lines 50-53. With reference to FIG. 1 of Hussain, a system 100 includes an embedded controller 110, a CPU chipset 120, a CPU 130 having a temperature sensor 132, a thermal management IC 140, a DC fan 160 and fan controller 150, and a power supply 170. Column 4, Lines 1-17. The temperature sensor 132 on CPU 130 is coupled with the thermal management IC 140, which includes its own on-board temperature sensor 146 for sensing a local temperature. Column 4, Lines 18-37. The embedded controller 110, which is controlled by the operating system of system 100, controls a CPU thermal management software module, with the assistance of chipset 120 and thermal management IC 140. Column 6, Lines 12-19.

The thermal management IC 140 includes a number of temperature setpoints, both software and hardware. Column 4, Lines 38-52. When a signal received from the CPU temperature sensor 132 (or from the on-board temperature sensor 146) indicates that a software temperature setpoint has been exceeded, the thermal management IC 140 issues an "ALERT#" signal to the embedded controller 110, and it is the embedded controller 110 that initiates any counter measures. Column 4, Lines 56-65; Column 7, Lines 21-66; FIG. 3. For example, the embedded controller 110 may direct the fan controller 150 to power up the fan 160, or the embedded controller 110 may direct the chipset 120 to throttle down the speed of a system clock signal 122 provided by the chipset to the CPU 130. Column 4, Line 65 through Column 5, Line 5; Column 5, Line 29 through Column 6, Line 8. When a signal received from the CPU temperature sensor 132 (or from the on-board temperature sensor 146) indicates that a hardware temperature setpoint has been exceeded, the thermal management IC 140 provides a shutdown signal to the power supply 170, and the power supply 170 then performs any necessary countermeasures (e.g., powering down the CPU 130). Column 5, Lines 13-22; Column 7, Lines 21-66; FIG. 3.

In sum, the CPU 130 includes a temperature sensor 132, but does not include any other elements of a thermal management system. Further, although the thermal management IC's on-board temperature sensor 146 may trigger countermeasures (see FIG. 3 of Hussain and accompanying text), those countermeasures are directed at the

CPU 130. Thus, Hussain does not teach a thermal management system for an integrated circuit die, wherein the elements of the thermal management system are integrated on the die itself. Rather, Hussain teaches a thermal management system that is dispersed across multiple components of a computer system (e.g., the embedded controller 110, the chipset 120, the CPU 130, and the thermal management IC 140).

In contrast, the presently claimed invention is directed to a thermal management system for an integrated circuit die, wherein a temperature detection element, a power modulation element, a control element, and a visibility element of the thermal management system are all formed directly on the die whose thermal characteristics are being monitored. For example, claim 1 recites:

1. A thermal management system *for an integrated circuit die* comprising:
 - a temperature detection element formed *directly on the integrated circuit die*, the temperature detection element including at least one temperature sensor having an output;
 - a power modulation element formed *directly on the integrated circuit die*, the power modulation element to reduce power consumption of the integrated circuit die in response to the output of the at least one temperature sensor;
 - a control element formed *directly on the integrated circuit die*, the control element including at least one register to provide an enable/disable bit for the thermal management system; and
 - a visibility element formed *directly on the integrated circuit die*, the visibility element to indicate a status of the output of the at least one temperature sensor.

Each of claims 9 and 17 recites similar limitations. Also, claim 37 recites:

37. A method of forming a thermal management system *for an integrated circuit die* comprising:
 - forming a temperature detection element *directly on the die*;
 - forming a power modulation element *directly on the die*;
 - forming a control element *directly on the die*; and
 - forming a visibility element *directly on the die*.

The claimed invention has integrated a thermal management system (including a temperature detection element, a power modulation element, a control element, and a visibility element) onto the die whose thermal characteristics are being monitored, rather than distributing these elements across multiple discrete components as taught in the cited prior art, thereby eliminating some components (e.g., a separate thermal management IC 140, as disclosed in Hussain). It is respectfully noted that **“the omission of an element and retention of its function is an indicia of unobviousness.”** M.P.E.P. § 2144.04(II)(B) (citing *In re Edge*, 149 U.S.P.Q. 556 (CCPA 1966)) (emphasis added).

The Examiner also cites the Gose patent. Gose discloses a conditional protection circuit 10 having a pulse-width modulation (PWM) circuit 12, a thermal shutdown circuit 20, and a TSD (thermal shutdown) detection circuit 16. Column 1, Lines 14-27; FIG. 1. However, Gose also fails to disclose, either individually or in combination with Hussain, the claimed thermal management system for an integrated circuit die.

In summary, the Hussain and Gose patents, either individually or in combination, fail to teach or suggest at least the above-noted limitations. Therefore, a prima facie case of obviousness can not be made out with respect to claims 1, 9, 17, and 37 based upon the Hussain and/or Gose patents, respectively, and each of claims 1, 9, 17, and 37 is nonobvious in view of Hussain and Gose.

Also, if an independent claim is nonobvious, then any claim depending from the independent claim is also nonobvious. M.P.E.P. § 2143.03 (citing *In re Fine*, 5 U.S.P.Q.2d 1596 (Fed. Cir. 1988)). Therefore, claims 6-8 are allowable as depending from nonobvious, independent claim 1. Similarly, claims 14 and 16 are allowable as depending from independent claim 9, claims 22 and 24 are allowable as depending from independent claim 17, and claims 38-40 are allowable as depending from independent claim 37.

Claims 25-27, 31, 32, and 49

Claim 25 recites:

25. A method comprising:
providing an enable bit to a register to activate a thermal management system of a die;
measuring a temperature on the die with a sensor of the thermal management system;
providing a first state at an output of the sensor when the temperature is below a trip point;
providing a second state at the sensor output when the temperature equals or exceeds the trip point;
in response to the sensor output having the second state, *engaging a power reduction mechanism for a specified time period* to reduce power consumption of the die;
polling the sensor output after expiration of the specified time period;
engaging the power reduction mechanism for at least another one of the specified time periods if the sensor output exhibits the second state; and
halting the power reduction mechanism when the sensor output exhibits the first state.

Hussain and Gose, either individually or in combination, fail to teach or suggest at least the following limitations recited in Claim 25: “in response to the sensor output having the second state, engaging a power reduction mechanism *for a specified time period* to reduce power consumption of the die”; “polling the sensor output *after expiration of the specified time period*”; and “engaging the power reduction mechanism for *at least another one of the specified time periods* if the sensor output exhibits the second state.” The Examiner has not set forth any specific evidence that these limitations are taught by the cited prior art references.

In sum, Hussain and Gose, either individually or in combination, fail to teach or suggest at least the above-noted limitations. Therefore, a prima facie case of obviousness can not be made out with respect to claim 25 based upon Hussain and/or Gose, respectively, and claim 25 is nonobvious in view of these references.

Also, if an independent claim is nonobvious, then any claim depending from the independent claim is also nonobvious. M.P.E.P. § 2143.03 (citing *In re Fine*, 5 U.S.P.Q.2d 1596 (Fed. Cir. 1988)). Therefore, claims 26, 27, 31, 32, and 49 are allowable as depending from nonobvious, independent claim 25.

Claims 34-36

Independent claim 34 recites:

34. An apparatus comprising:

- a temperature detection element, the temperature detection element including at least one temperature sensor having an output;
- a power modulation element, the power modulation element to reduce power consumption of an integrated circuit die in response to the output of the at least one temperature sensor;
- a visibility element, the visibility element to indicate a status of the output of the at least one temperature sensor, the visibility element including a register to indicate the status of the output of the at least one temperature sensor;
- a register providing a *sticky bit*;
- a counter to count a number of lost clock cycles resulting from operation of the apparatus***; and
- circuitry to generate an interrupt when the output of the at least one temperature sensor transitions to a different state.

Hussain and Gose, either individually or in combination, fail to teach or suggest at least the limitations of “a register providing a sticky bit” and “a counter to count a number of lost clock cycles resulting from operation of the apparatus,” as recited in claim 34, and the Examiner has not set forth any specific evidence that these limitations are taught by the cited prior art references. In fact, the Examiner specifically states that the cited prior art fails to disclose a “counter to count the lost clock cycles.” Office Action, at page 4.

In sum, Hussain and Gose, either individually or in combination, fail to teach or suggest at least the above-noted limitations. Therefore, a prima facie case of obviousness

can not be made out with respect to claim 34 based upon Hussain and/or Gose, respectively, and claim 34 is nonobvious in view of these references.

Also, if an independent claim is nonobvious, then any claim depending from the independent claim is also nonobvious. M.P.E.P. § 2143.03 (citing *In re Fine*, 5 U.S.P.Q.2d 1596 (Fed. Cir. 1988)). Therefore, claims 35 and 36 are allowable as depending from nonobvious, independent claim 25.

Claim Objections - Allowable Subject Matter

Claims 3-5, 10-13, 15, 18-21, 23, and 33 were objected to as being dependent upon a rejected base claim, but each of these claims would be allowable if rewritten in independent form. Office Action, at page 4. As set forth above, each of independent claims 1, 9, 17, and 25 is patentable in view of the cited prior art. Thus, Applicants submit that each of claims 3-5, 10-13, 15, 18-21, 23, and 33 is patentable as written in dependent form.

CONCLUSION

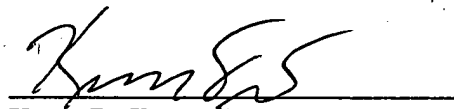
Applicants submit that claims 1-27, 31-40, and 49 are in condition for allowance and respectfully request allowance of such claims.

Please charge any shortages and credit any overages to our Deposit Account No. 02-2666.

Respectfully submitted,

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